



**Grad Conn Ltd.**  
格瑞康實業有限公司

# Component Temperature Check List

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填表人(Prepare By): 管葉波

零件名稱	接腳/端子外鍍層	重複焊錫次數	溫升	SMT最大耐溫 $^{\circ}\text{C}$ 幾秒	DIP最大耐溫 $^{\circ}\text{C}$ 幾秒	手焊最大耐溫 $^{\circ}\text{C}$ 幾秒
Component Description	Lead /Terminal Coating	Resolder Times	$\Delta\text{T}(^{\circ}\text{C})$	SMT Max Temp. Time	Wave Solder Max Temp. Time	Hand Solder Max Temp. Time
Connectors with LCP insulators.	Au	3	30 $^{\circ}\text{C}$	280 $^{\circ}\text{C}$ /10 sec.	250 $^{\circ}\text{C}$ /5~10 sec.	380 $^{\circ}\text{C}$ /3~5 sec.

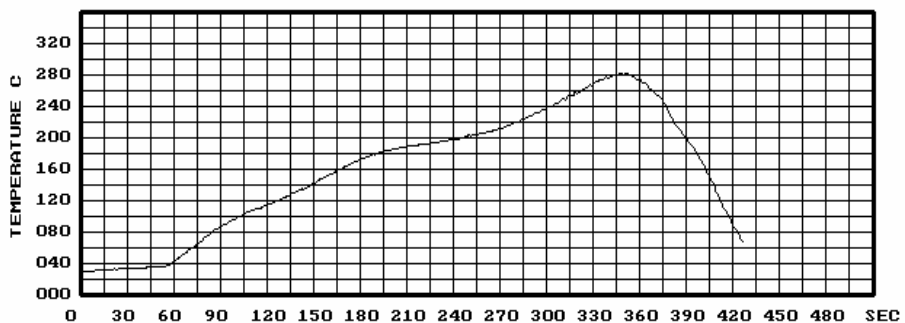
## 溫度曲線圖

### Component Temp. Profile

FORSURE SMT REFLOW M/C TEST SYSTEM

CURRENT TEMPERATURE 68  $^{\circ}\text{C}$

MAXIMUM TEMPERATURE 282  $^{\circ}\text{C}$



START TEST

QUIT

PCB TYPE: \_\_\_\_\_

STOP TEST & QUIT

RESET

DATE: \_\_\_\_\_

## 接腳/端子鍍層剖面圖

### Lead / Terminal Cross Section

